

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kazuaki YAZAWA
Filed: Filed Concurrently Herewith
Title of Invention: HEAT DISSIPATING STRUCTURE FOR AN
ELECTRONIC DEVICE

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INFORMATION DISCLOSURE STATEMENT

Mail Stop Patent Application
Commissioner for Patents
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Sir:

Enclosed are copies of references which were cited in
the Japanese Patent Office in connection with the corresponding
Japanese patent application. Also enclosed is a copy of Form
PTO-1449. Entry of this Information Disclosure Statement and an
early examination on the merits are respectfully solicited.

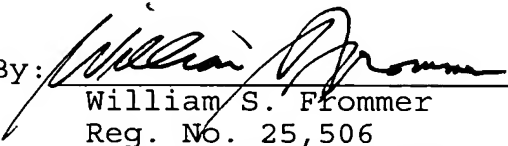
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450134-04839

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Respectfully submitted,

FROMMER LAWRENCE & HAUG LLP
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Based on Form PTO-1449 (3/90)	ATTY. DOCKET NO. 450134-04839	SERIAL NO. Filed Concurrently Herewith
	APPLICANT Kazuaki YAZAWA	
	FILING DATE Filed Concurrently Herewith	GROUP

U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						
	AE						
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FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES NO
	AL						
	AM						
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	AP						

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)		
AR		Patent Abstracts of Japan 09-212258 dated 08/15/97
AS		Allan D. Kraus et al., "DESIGN AND ANALYSIS OF HEAT SINKS", 1995 A Wiley-Interscience Publication, pages 286-291
AT		Akash Jain et al., "BUOYANCY-DRIVEN FLOW IN CHANNELS WITH IN-LINE PIN FINS" Proceedings of ASME NHTC'01, 35th National Heat Transfer Conference Anaheim, California, June 10-12, 2001, pages 1-8
AU		William K. Coxe III et al., "EXPERIMENTAL MODELING OF THE PASSIVE COOLING LIMIT OF NOTEBOOK COMPUTERS", 2002 Inter Society Conference on Thermal Phenomena, pages 15-21

EXAMINER	DATE CONSIDERED
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* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.